Measurements and simulations of surface and bulk radiation damage effects in silicon detectors for phase II CMS outer tracker



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Introduction

- From 2026 the **HL-LHC** will start, with a very high fluence, up to 1×10¹⁵ 1MeV (2×10^{16}) n_{eq} /cm² in the outer (inner) tracker. A new tracker detector will be installed in CMS.
- Two different Hamamatsu Photonics (HPK) sensor technologies have been investigated as support for the final choice: standard FZ290 and thinned **FZth240**.
- An intense activity on the Si/SiO2 surface and bulk radiation damage effects have been carried out:
 - development of a surface radiation damage effects model based on [1];
 - measurements on the test structures before and after irradiations:

X-rays

(3)

1x10

1x10

1x10

1x10°

1x10

T=20°C

X-rays and neutrons

Experimental setup



IRRADIATION FACILITIES

Padova -> X-rays

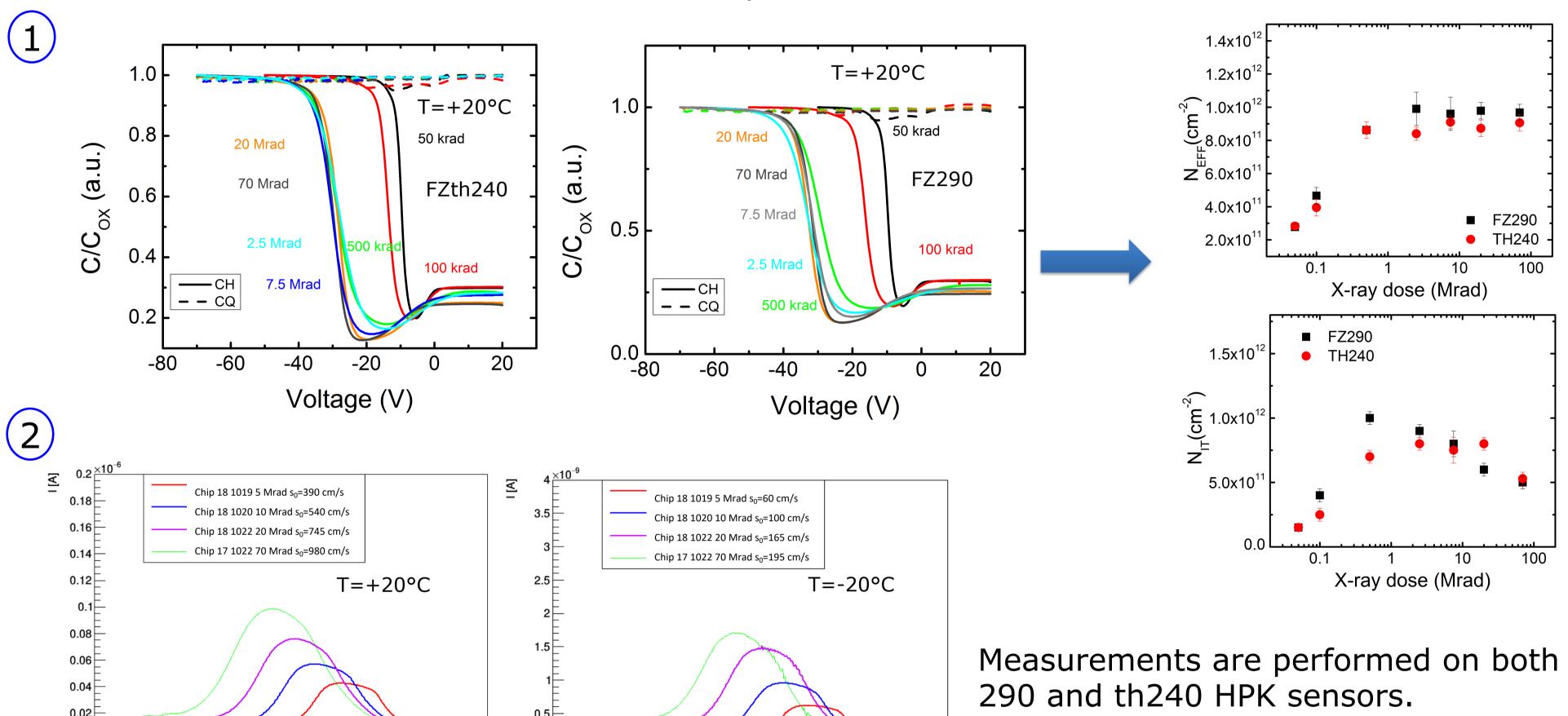
doses range: 50 krad - 70 Mrad(SiO₂)

Ljubjana -> neutron (combined to X-rays):

doses range: 5 Mrad(SiO₂)+ 1.5×10^{14} (1 MeV n/cm²) 10 Mrad(SiO₂)+ $3x10^{14}$ (1 MeV n/cm²) 20 Mrad(SiO₂)+ $6x10^{14}$ (1 MeV n/cm²) 70 Mrad(SiO₂)+ 1×10^{15} (1 MeV n/cm²) Expected in the outer tracker after 3000fb⁻¹

Surface damages

Measurements after X-rays to validate the surface model



5 Mrad

10 Mrad

70 Mrad

20 Mrad

T=-20°C

Bias Voltage (V)

300

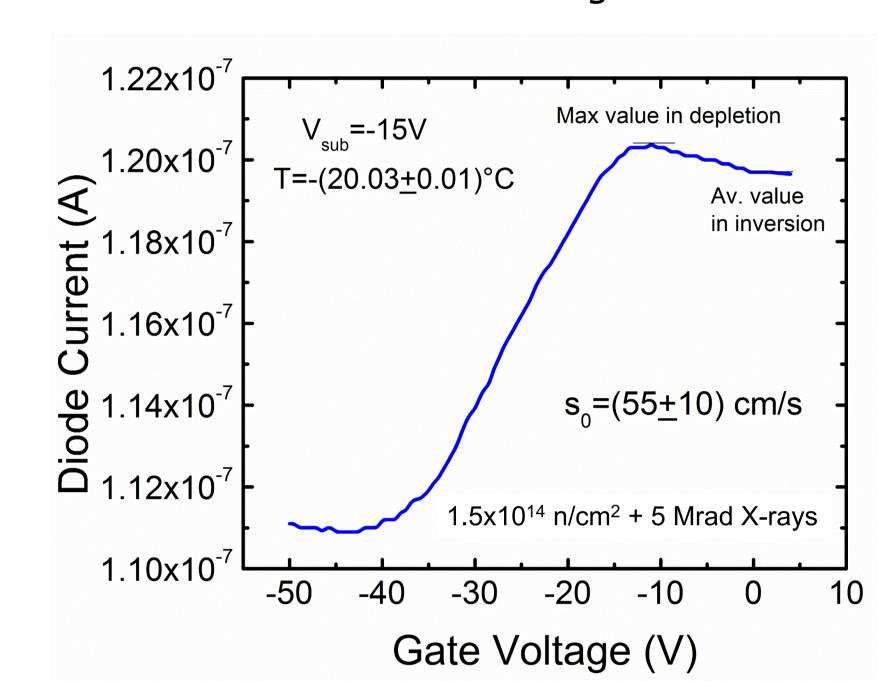
200

100

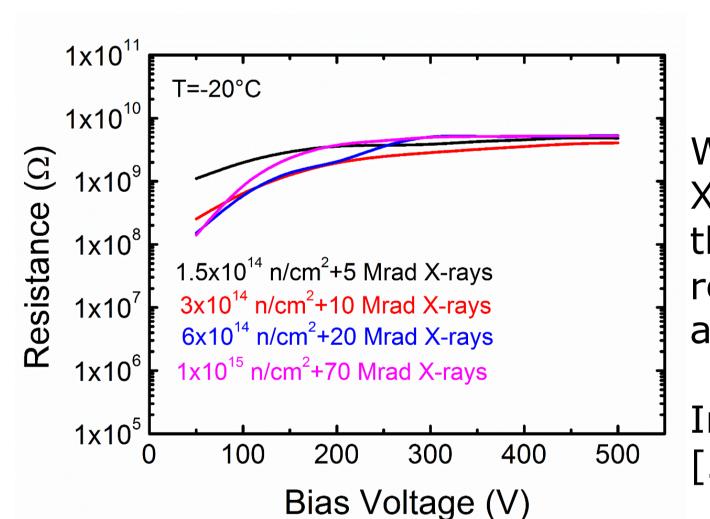
- From the CV curves the N_{eff} and N_{it} parameters are extracted. A saturation of the V_{FB} is observed. 2) IV curves for the irradiated gated
- diodes show an increase of the surface generation velocity vs dose
- 3) Interstrip resistance curves for different doses show a **strong** dependence on temperature

Combined Bulk and Surface

Measurements after X-rays and neutrons to couple surface and damage effects



IV on the gated diodes irradiated with X-ray + neutrons -> whole characterization on going.



With neutrons and X-rays irradiations the Interstrip resistance saturate at high values.

In agreement with [2.]

"New Perugia model"

Bias Voltage (V)

5 Mrad

20 Mrad

Modern TCAD simulation tools -> different damage mechanisms interact in a non-trivial way

Donor \$\(0.23 \) eV 0.42 eV ↑

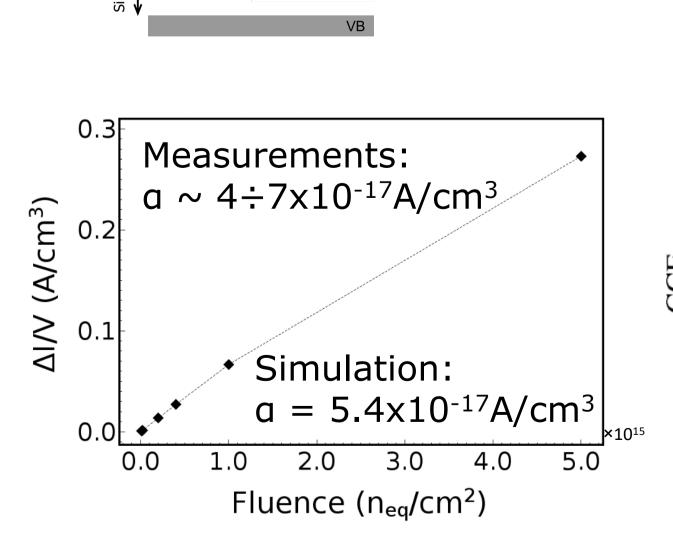
Bulk and **surface** radiation damage taken into account by means of the introduction of deep level radiation induced traps whose parameters are physically meaningful.

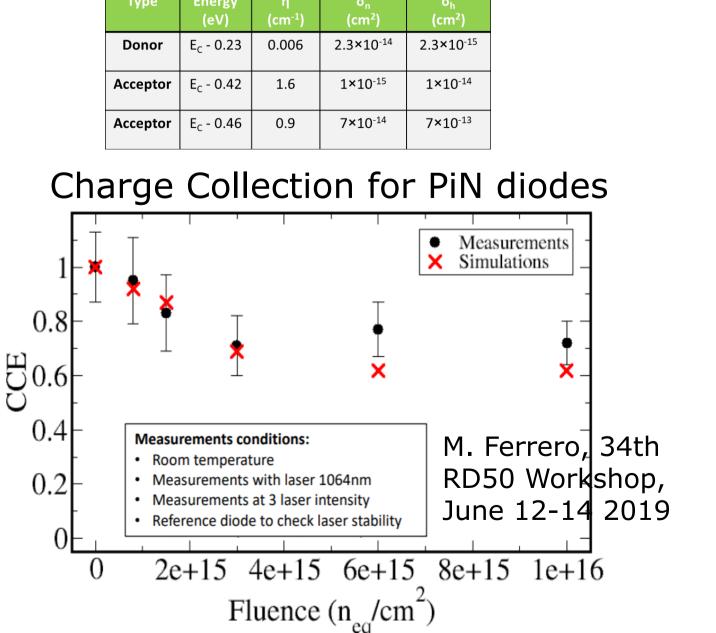
Bulk model validation

Surface model validation Energy (eV) **Band width** (cm⁻²) $D_{IT} = D_{IT}(\Phi)$ $E_C \le E_T \le E_C - 0.56$ 0.56 Acceptor $E_V \le E_T \le E_V + 0.6$ 0.60 $D_{IT} = D_{IT}(\Phi)$ Gated Diodes MOS capacitors 8e-08 HPK FZ290 10 Mrad Dashed line: Measurer 6e-08 50 krad _4e-081 2e-08 Meas. QS

1x10

1x10[°]





Conclusions

In view of the upcoming OT tracker upgrade for the HL-LHC an intense characterization of irradiated sensor started.

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Sensors have been irradiated with X-rays before (50 krad - 70 Mrad(SiO₂)) and neutrons then (1.5e14 - 1e15 (1 MeV n/cm²)) to study the surface and the combined bulk + surface damage effects.

The new measurements on surface and bulk damages have been presented. Similar behavior between FZ290 and FZth240.

Gate Voltage (V)

A model for the bulk and surface damages has been developed "New Perugia model" to provide a general radiation damage model. A further [1, 3] comparison between measurements and simulations confirms the validity of the model.

References

- F. Moscatelli, et al., *Analysis of surface Radiation* Damage Effects at HL-LHC Fluences: comparison of different technology options, Nucl. Instr. Methods Phys. Res. A, 2018.
- Jan-Ole Gosewisch et al. Interstrip Isolation of p-type Strip Sensors, 14th "Trento" Workshop on Advanced Silicon **Radiation Detectors**
- 3. F Moscatelli, et al., Measurements and simulations of surface radiation damage effects on IFX and HPK test structures, Nucl. Instr. Methods Phys. Res. A, 2019.